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Indium Corporation Webinar to Explore Low-Silver Solder Alloys and Reliability Tradeoffs

CLINTON, N.Y., November x, 2026 — Indium Corporation® will host a webinar exploring the relationship between silver content, solder alloy cost, and solder joint reliability as rising silver prices prompt electronics manufacturers to consider more cost-effective alternatives. The session will be presented by Kevin Brennan, Product Manager - PCB Assembly Solder Paste, on November 30 at 8 a.m. EST.

Titled *"The Silver Tradeoff: How Low Can You Go? Exploring Traditional and Next-Generation Low-Silver Solder Alloys,"* the webinar will examine traditional low-silver SAC alloys alongside emerging microalloyed alternatives, exploring how reductions in silver content affect solder joint reliability and material costs. Drawing on published reliability studies, metallurgical principles, and practical application considerations, Brennan will discuss the tradeoffs associated with lowering silver content and how advancements in alloy technology can help address them. Attendees will gain a better understanding of how to select the right solder alloy for their specific applications, balancing potential cost savings with performance and long-term reliability.



Kevin Brennan

The webinar is free to attend. To register, visit: https://indium.webex.com/weblink/register/r4d6ccc4c5b6411c3144137257fb94cf9.

Kevin Brennan is the Global Product Manager for PCB Assembly Solder Paste. He is responsible for driving growth of Indium Corporation's PCB assembly products across the Americas and Europe, with a specific focus on Durafuse® HR. He leads new solder paste initiatives, pursues market opportunities, and analyzes competitive intelligence to drive product adoption. Collaborating closely with R&D, sales, and production, he also provides marketing support and technical training to customers and internal teams. Brennan holds a bachelor's degree in chemical engineering from the University at Buffalo and a master's degree in engineering management from Clarkson University. He is also a Lean Six Sigma Green Belt and a Certified SMT Process Engineer.

About Indium Corporation

Indium Corporation® is a premier materials refiner, smelter, manufacturer, and supplier to the global electronics, semiconductor, thin-film, and thermal management markets. Products include solders and fluxes; brazes; thermal interface materials; sputtering targets; indium, gallium, germanium, and tin metals and inorganic compounds; and NanoFoil®. Founded in 1934, the company has global technical support and factories located in China, Germany, India, Malaysia, Mexico, Singapore, South Korea, the United Kingdom, and the U.S.

For more information about Indium Corporation, visit www.indium.com or email jhuang@indium.com. You can also follow our experts, From One Engineer To Another® (#FOETA), at www.linkedin.com/company/indium-corporation/.

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